



RF360
Europe GmbH

Data sheet

SAW RF downlink filter

Base stations
R-GSM

Series/type: B5057
Ordering code: B39941B5057U410

Date: June 03, 2019

Version: 2.3

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A Qualcomm – TDK Joint Venture

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1 Application

- Low-loss filter for Basestation R-GSM, transmit path (Tx)
- Usable pass band 39 MHz
- Unbalanced to unbalanced operation
- No matching required
- Filter impedance 50 Ω

2 Features

- Package code DCC6C
- Package size 3.0 \pm 0.1 mm \times 3.0 \pm 0.1 mm
- Package height 1.1 \pm 0.125 mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)

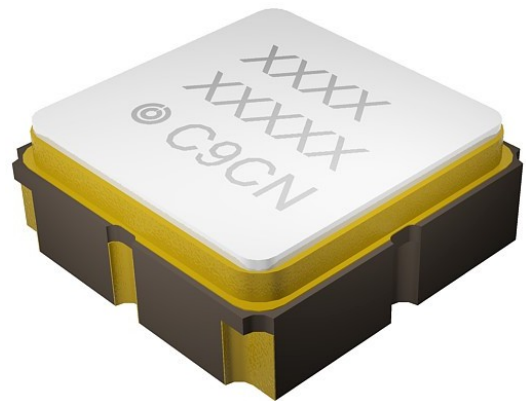
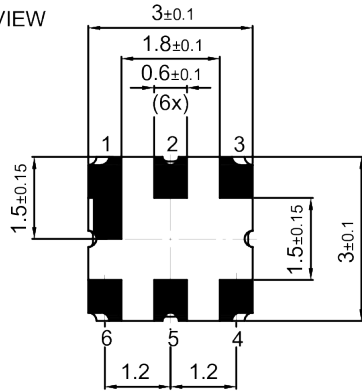


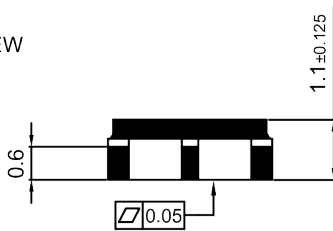
Figure 1: Picture of component with example of product marking.

3 Package

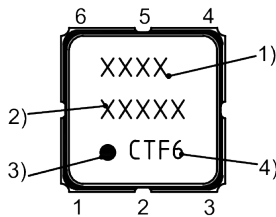
BOTTOM VIEW



SIDE VIEW



TOP VIEW



SIDE VIEW



- 1) Device designation
- 2) Last five digits of the lot number
- 3) Marking for pad number 1
- 4) Example of production location and date code

Land pattern
THRU VIEW

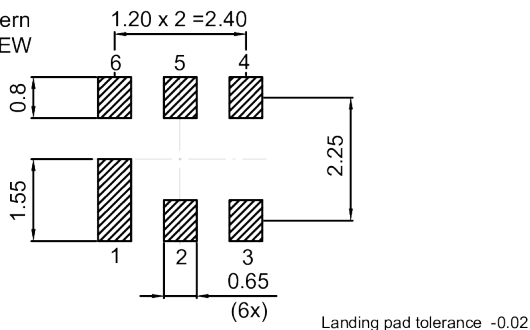


Figure 2: Drawing of package. See Sec. Package information (p. 18).

4 Pin configuration

- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground

5 Matching circuit

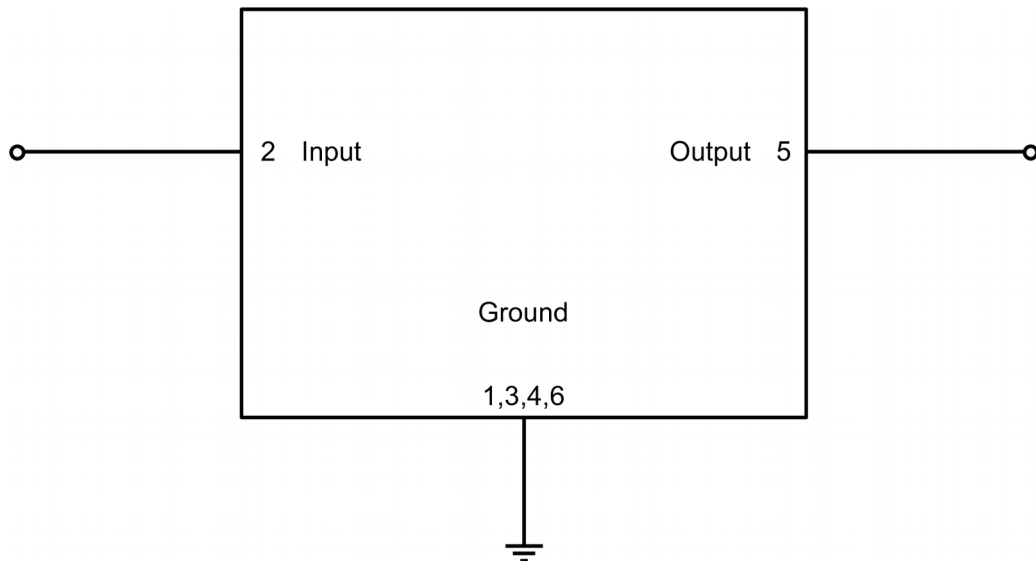


Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification	T_{SPEC}	= -30 °C ... +80 °C
Input terminating impedance	Z_{IN}	= 50 Ω
Output terminating impedance	Z_{OUT}	= 50 Ω

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency		f_C	—	940.5	—	MHz
Maximum insertion attenuation	921... 960	MHz	α_{max}	2.7	4.0 ¹⁾	dB
Amplitude ripple (p-p)	921... 960	MHz	$\Delta\alpha$	1.4	3.0 ²⁾	dB
Maximum VSWR			VSWR _{max}			
@ input port	921... 960	MHz		2.3	3.0 ³⁾	
@ output port	921... 960	MHz		2.6	3.0 ³⁾	
Minimum attenuation			α_{min}			
	0.3 ⁴⁾ ... 800	MHz		25	47	dB
	800... 880	MHz		26	39	dB
	880... 905	MHz		20 ⁵⁾	31	dB
	905... 915	MHz		2 ⁶⁾	6	dB
	980... 985	MHz		23	42	dB
	985... 1005	MHz		30	34	dB
	1005... 1025	MHz		30	34	dB
	1025... 1760	MHz		27	34	dB
	1760... 2000	MHz		28	32	dB
	2000... 4000	MHz		18	23	dB

- 1) 3.0 dB at 25°C.
- 2) 2.0 dB at 25°C.
- 3) 2.8 dB at 25°C.
- 4) Final electrical test starts at 10 MHz.
- 5) 28 dB at 25°C.
- 6) 3 dB at 25°C.

Temperature range for specification	T_{SPEC}	= -40 °C ... +85 °C
Input terminating impedance	Z_{IN}	= 50 Ω
Output terminating impedance	Z_{OUT}	= 50 Ω

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Maximum insertion attenuation						
	921... 960	MHz	—	2.7	4.5 ¹⁾	dB
Amplitude ripple (p-p)						
	921... 960	MHz	—	1.4	3.2 ²⁾	dB
Maximum VSWR						
@ input port	921... 960	MHz	—	2.3	3.0 ³⁾	
@ output port	921... 960	MHz	—	2.6	3.0 ³⁾	
Minimum attenuation						
	0.3 ⁴⁾ ... 800	MHz	25	47	—	dB
	800... 880	MHz	26	39	—	dB
	880... 905	MHz	20 ⁵⁾	31	—	dB
	905... 915	MHz	2 ⁶⁾	6	—	dB
	980... 985	MHz	23	42	—	dB
	985... 1005	MHz	30	34	—	dB
	1005... 1025	MHz	30	34	—	dB
	1025... 1760	MHz	27	34	—	dB
	1760... 2000	MHz	28	32	—	dB
	2000... 4000	MHz	18	23	—	dB

¹⁾ 3.0 dB at 25°C.

²⁾ 2.0 dB at 25°C.

³⁾ 2.8 dB at 25°C.

⁴⁾ Final electrical test starts at 10 MHz.

⁵⁾ 28 dB at 25°C.

⁶⁾ 3 dB at 25°C.

7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +125\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +125\text{ °C}$	
DC voltage	$ V_{DC} = 5.0\text{ V}$	
ESD voltage		
	$V_{ESD}^{2)} = 125\text{ V}$	Machine model.
	$V_{ESD}^{3)} = 350\text{ V}$	Human body model.
	$V_{ESD}^{4)} = 1000\text{ V}$	Charged device model.
Input power @ input port: 921 ... 960 MHz	$P_{IN} = 10\text{ dBm}$	

¹⁾ Not valid for packaging material. Please refer to definition of Shelf life (p. 17).

²⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

³⁾ According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁴⁾ According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficient

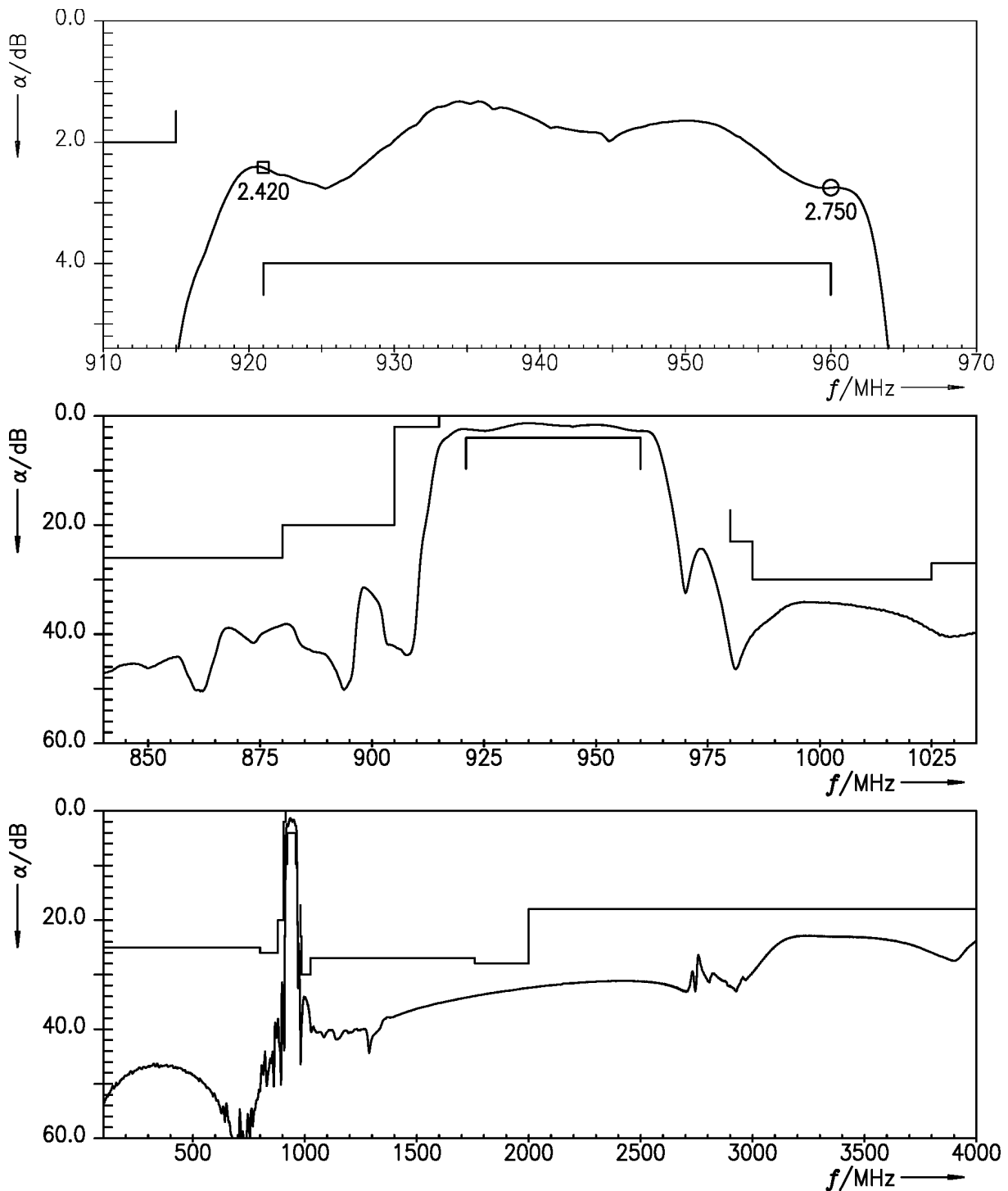


Figure 4: Attenuation.

9 Reflection coefficients

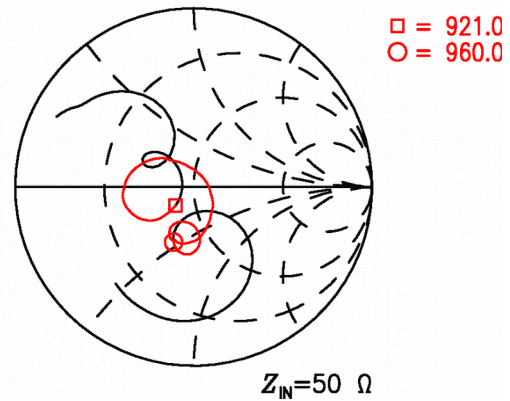
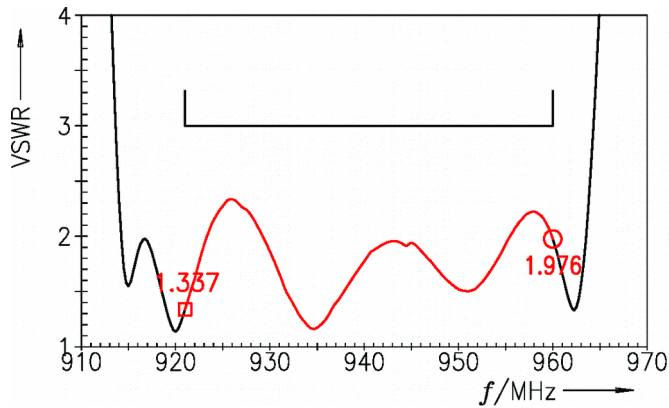


Figure 5: Reflection coefficient at input port.

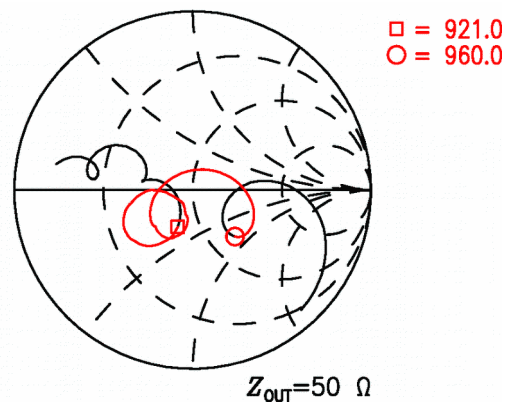
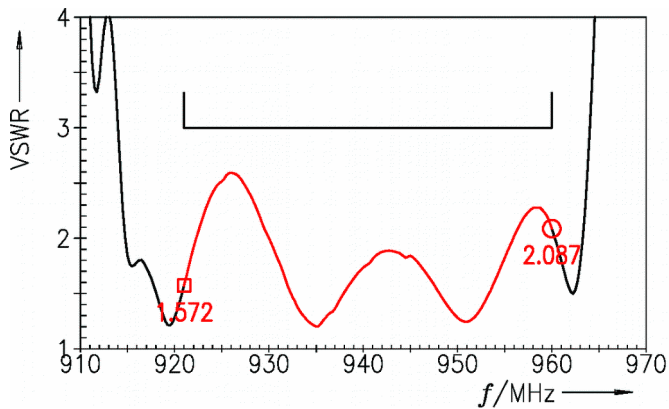


Figure 6: Reflection coefficient at output port.

10 Packing material

10.1 Tape

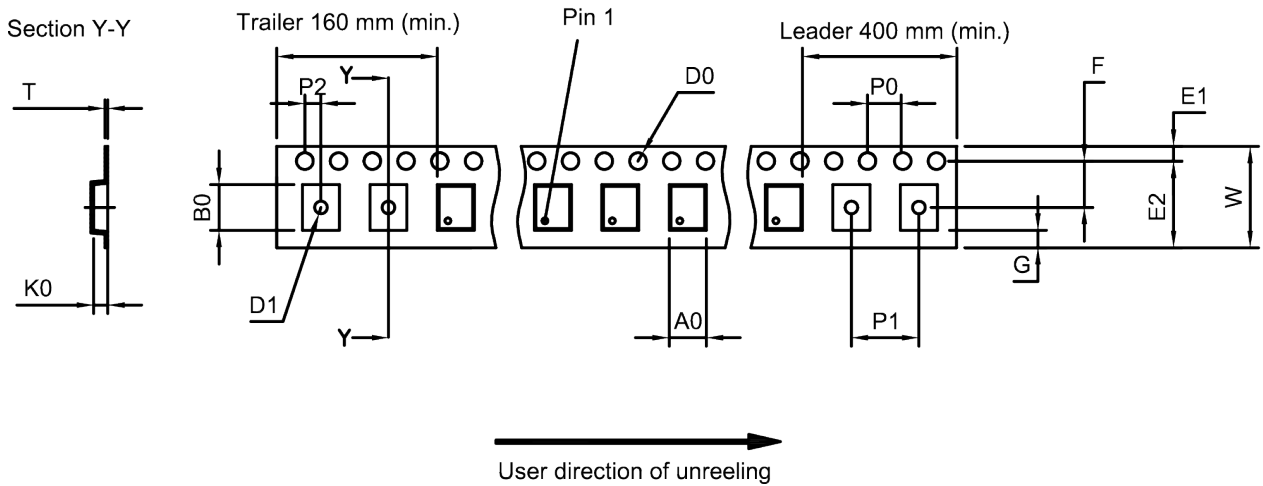


Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A ₀	3.25±0.1 mm	E ₂	10.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	3.3±0.1 mm	F	5.5±0.05 mm	P ₂	2.0±0.1 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.3±0.05 mm
D ₁	1.5 mm (min.)	K ₀	1.5±0.1 mm	W	12.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

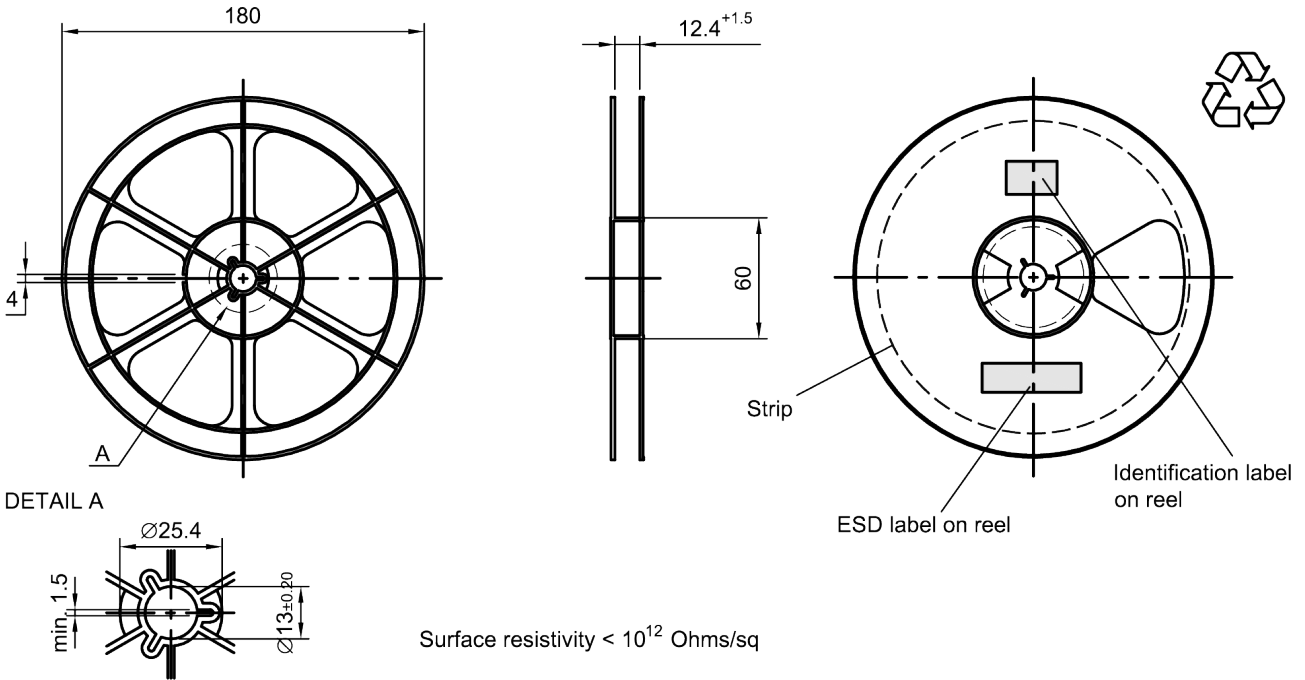
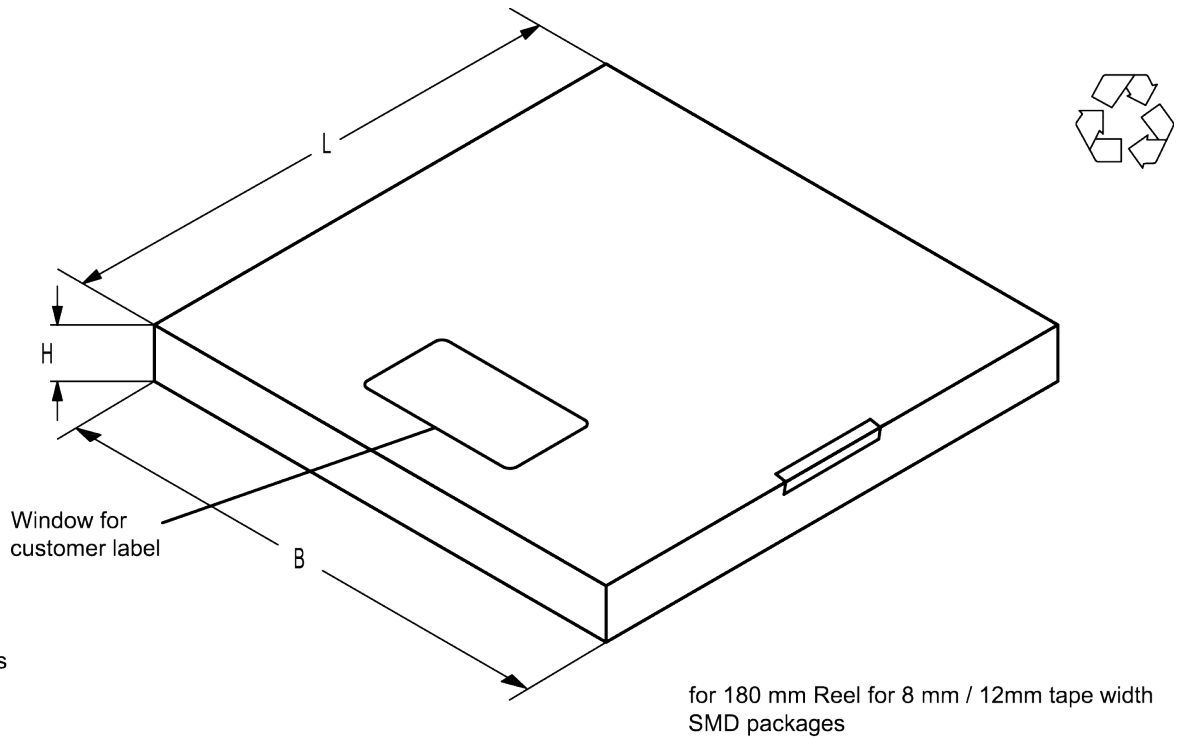


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.



Dimensions

- L = 182
- B = 185
- H = 26

Figure 9: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

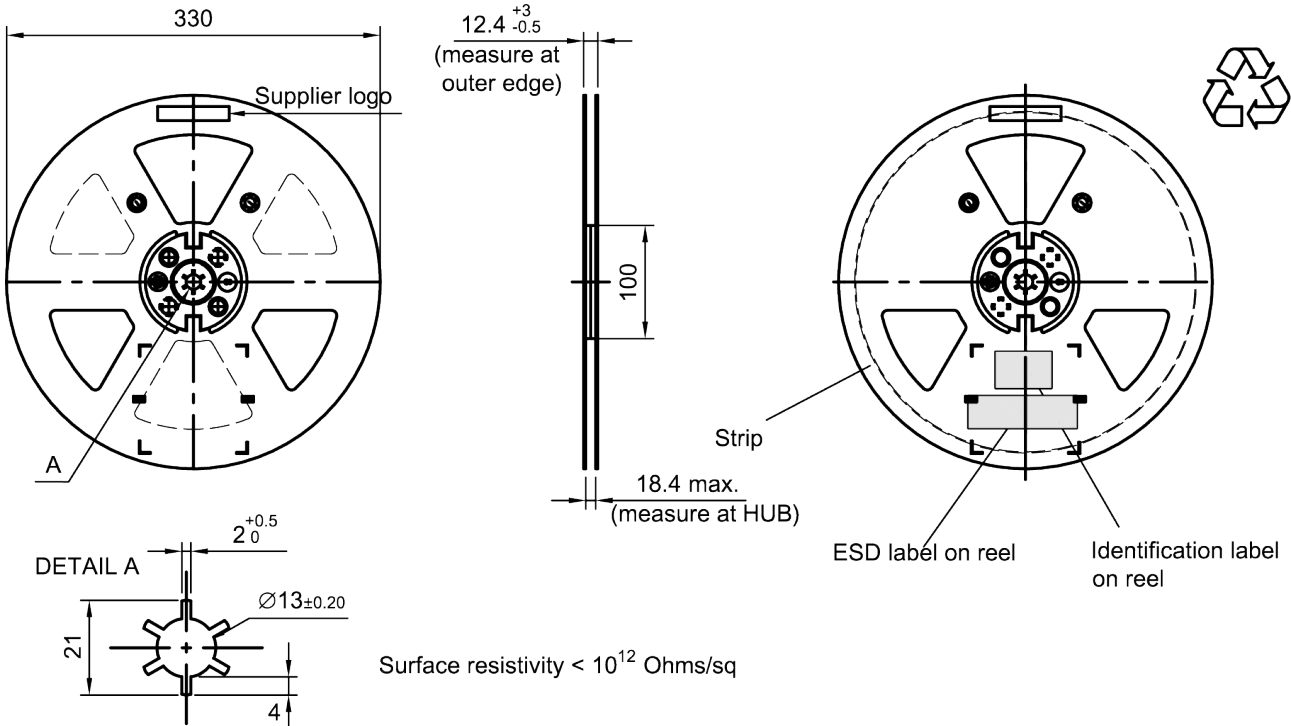
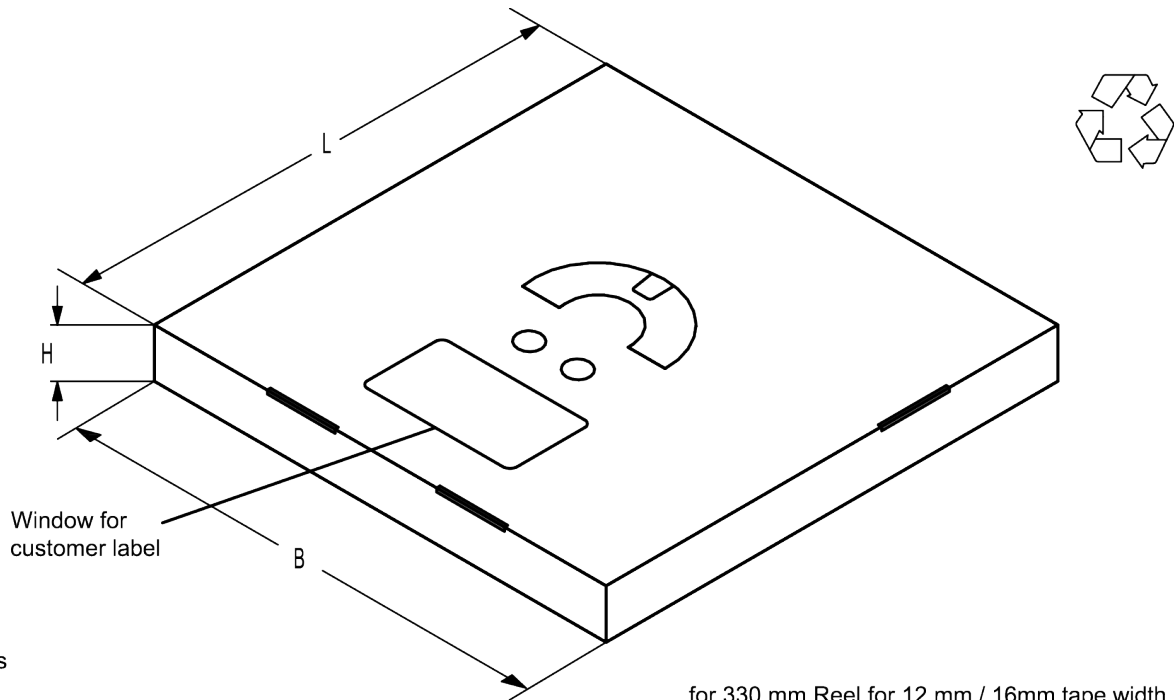


Figure 10: Drawing of reel (first-angle projection) with diameter of 330 mm.



Dimensions

- L = 340
- B = 340
- H = 25

for 330 mm Reel for 12 mm / 16mm tape width SMD packages

Figure 11: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with device designation, lot number, as well as production location and date code.

- Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

- Lot number: The last 5 digits of the lot number are used for the marking.

Example: 12345

- Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

1 st digit (day)						2 nd digit (year)				3 rd digit (month)			
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	A	21	M	2010	A	2022	P	Jan	1	Jul	7
2	2	12	B	22	N	2011	B	2023	R	Feb	2	Aug	8
3	3	13	C	23	P	2012	C	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	T	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	T	2015	F	2027	V	Jun	6	Dec	D
7	7	17	H	27	U	2016	H	2028	W				
8	8	18	J	28	V	2017	J	2029	X				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	X	2019	L	2031	A				
				31	Z	2020	M	2032	B				
						2021	N	and so on					

Table 2: Production date code.

Example of how to decode production location and date code:

Code: **C T F 6**

Location: C → Wuxi

Day: T → 26th

Year: F → 2015

Month: 6 → June

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

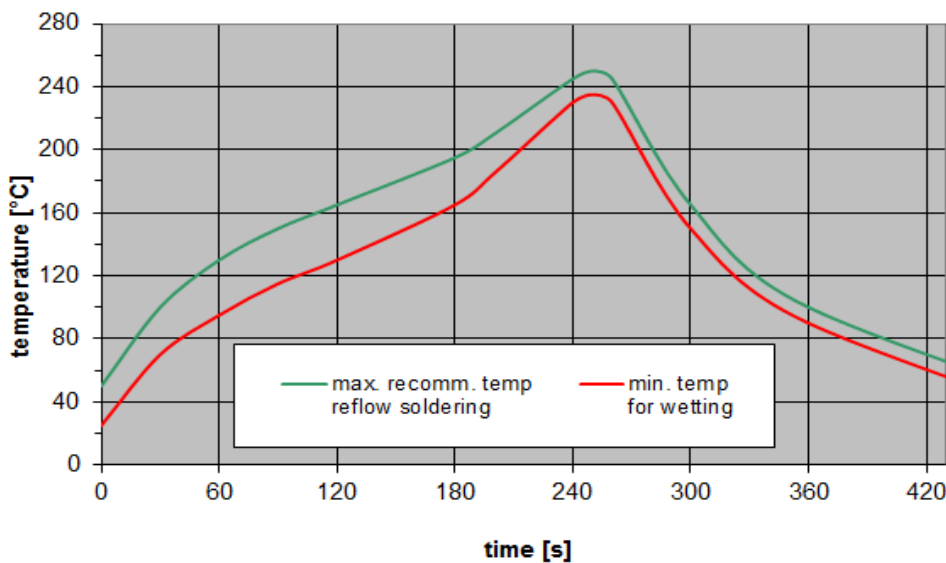


Figure 12: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Shelf life

The shelf life of components is determined by solderability of the package terminals. It is specified as 2 years from manufacturing date assuming the following conditions:

- storage in original packaging and non-aggressive atmosphere,
- storage temperature ranging from -25 °C to $+40\text{ °C}$, and
- storage humidity with $\leq 75\%$ r.h. mean annual humidity, $\leq 95\%$ r.h. for max. 30 days / year, and no dew condensation.

14 Cautions and warnings

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14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

15 Important notes

The following applies to all products named in this publication:

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3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
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